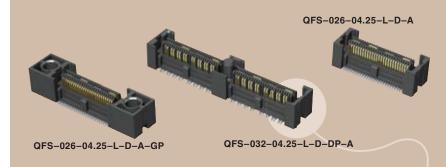
(0,635mm) .025" **QFS SERIES**





RUGGED GROUND PLANE SOCKET

SPECIFICATIONS

For complete specifications and recommended PCB layouts see www.samtec.com?QFS

Insulator Material: Liquid Crystal Polymer

Contact & Ground Plane Material: Phosphor Bronze

Plating: Au over 50μ" (1,27μm) Ni (Tin on Ground Plane Tail)

Current Rating: Contact: 1.6A @ 95°C Ground Plane: 9.2A @ 95°C Voltage Rating: 300 VAC mated with QMS Operating Temp: -55°C to +125°C RoHS Compliant:



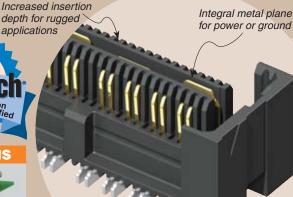
- Increased insertion depth
- Integral guide post

Board Mates:

Cable Mates: Q2DA, 6QCD 6QDP, 6QP



applications



Type

-D

–D

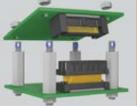
-DP



APPLICATION **SPECIFIC**

- Power & RF options
- Edge Mount
- Guide Posts
- Without PCB Alignment Pins
- Hot Pluggable Call Samtec.

APPLICATIONS



See SO Series for precision machined standoffs.

Performance data for other stack heights and complete test data available at www.samtec.com?QFS or contact sig@samtec.com

Processing: Lead-Free Solderable:

SMT Lead Coplanarity: (0,10mm) .004" max (026-078) (0,15mm) .006" max (104)

Board Stacking: For applications requiring

more than two connectors per board or 4 banks or more. contact ipg@samtec.com



Note: Some lengths, styles and options are non-standard, non-returnable.

LEAD PINS PER ROW **PLATING** NO. OF PAIRS STYLE

OPTION

11mm Stack Height

Single-Ended Signaling

Differential Pair Signaling

Differential Pair Signaling

LEAD STYLE from chart

-016, -03<u>2</u>, -048, -064 (16 pairs per bank = -D-DP)

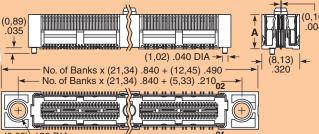
-026, -<u>05</u>2.

(52 total pins per bank = -D)

(3.35)\.132 DIA

-078, –104

No. of Banks x (21,34) .840 + (1,02) .040 → ←(2,10).083 -(21,34) .840 (8,13) .320 (0,635) .009 -D -D-DP



(-04.25 lead `style only) 10μ" (0,25μm) Gold on Signal Pins and Ground Plane (Tin on Signal Pin tails, and Ground Plane tails)

–SL (-06.25 lead style only) 10μ" (0,25μm) Gold on Signal Pins and Ground Plane (Tin on Signal Pin tails, and Ground Plane tails)

(0,10)

–D = Single-Ended

Rated @ 3dR

Insertion Loss

8 GHz / 16 Gbps

7.5 GHz / 15 Gbps

7 GHz / 14 Gbps

TYPE

-D-DP = Differential Pair (-04.25 only)

MATED HEIGHT* **QMS LEAD STYLE LEAD** 05.75 -06.75 -09.75 -04.25 10mm 11mm 14mm (9.42)-06.2512mm 13mm 16mm

*Processing conditions will affect mated height.

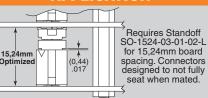
-GP = Guide

OTHER

OPTION

Holes (–052 pin and 04,25 lead style only for mating with 6QP Series assembly. Call Samted for other sizes)

APPLICATION



INDUSTRY STANDARD	INTERCONNECTS	
	TERMINAL	SOCKET
Stackable USB™	ASP-129637-01	ASP-129646-01
SUMIT™	ASP-129637-01	ASP-129646-01
PCI/104-Express™	ASP-129637-03	ASP-129646-03

-GP OPTION Due to technical progress, all designs, specifications and components are subject to change without notice.

WWW.SAMTEC.COM